

## C0603C111JATACTU

Aliases (CO603C111JATAC7867) SMD Comm X8G HT150C, Ceramic, 110 pF, 5%, 250 VDC, X8G, SMD, MLCC, High Temperature, Ultra-Stable, 0603, 0.5 mm



Click here for the 3D model.

General Information	
Series	SMD Comm X8G HT150C
Style	SMD Chip
Description	SMD, MLCC, High Temperature, Ultra-Stable
Features	High Temperature, Ultra-Stable
RoHS	Yes
Termination	Tin
Marking	No
AEC-Q200	No
Typical Component Weight	3.7 mg
Shelf Life	78 Weeks
MSL	1

	Specifications		
0603	Capacitance	110 pF	
1.6mm +/-0.15mm	Measurement Condition	1 MHz 1.0Vrms	
0.8mm +/-0.15mm	Tolerance	5%	
0.8mm +/-0.07mm	Voltage DC	250 VDC	
0.5mm MIN	Dielectric Withstanding Voltage	625 VDC	
0.35mm +/-0.15mm	Temperature Range	-55/+150°C	
	Temp. Coefficient	X8G	
	Capacitance Change with	30 ppm/C, 1MegaHz 1.0Vrms	
T&R, 180mm, Paper Tape	Reference to +25°C and 0 VDC Applied (TCC)		
4000	Dissipation Factor	0.1% 1 MHz 1.0Vrms	

Aging Rate

Insulation Resistance

 Dimensions

 Chip Size
 0603

 L
 1.6mm +/-0.15mm

 W
 0.8mm +/-0.15mm

 T
 0.8mm +/-0.07mm

 S
 0.5mm MIN

 B
 0.35mm +/-0.15mm

## Packaging Specifications

Packaging Quantity 4000	Packaging	T&R, 180mm, Paper Tape
	Packaging Quantity	4000

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0% Loss/Decade Hour: Referee

Time is 1000 Hours

100 GOhms